SiC JFET Division

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Silicon Carbide (SiC) JFET -EliteSiC, Power N-Channel, TO-247-4L, 750 V, 4.8 mohm

DATASHEET

UJ4N075005K4S





Part Number	Package	Marking		
UJ4N075005K4S	TO-247-4L	UJ4N075005K4S		



Rev. C, January 2025

Description

Qorvo's UJ4N075005K4S is a 750 V, $4.8m\Omega$ high-performance Gen 4 normally-on SiC JFET transistor. This device exhibits ultra-low on resistance ($R_{DS(on)}$) in a TO-247-4L package, making it an ideal fit to address the challenging thermal constraints of solid-state circuit breakers and relay applications. Additionally, the JFET is a robust device technology capable of the high-energy switching required in circuit protection applications.

Features

- Single digit on-resistance
- Operating temperature: 175°C (max)
- High pulse current capability
- Excellent device robustness
- Silver-sintered die attach for excellent thermal resistance
- Short circuit rated
- RoHS compliant
- AECQ Qualified

Typical applications

- Solid State / Semiconductor Circuit Breaker
- Solid State / Semiconductor Relay
- Battery Disconnects
- Surge Protection
- Inrush Current Control
- Induction heating





Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V _{DS}		750	V
Cata-source voltage	V _{GS}	DC	-30 to +3	V
Gate-source voltage		AC ¹	-30 to +30	V
Continuous drain current ²	I _D	T _C < 127°C	120	А
Pulsed drain current ³	I _{DM}	T _C = 25°C	588	А
Short circuit withstand time	t _{sc}	V _{DS} = 400V, T _{J(START)} = 175°C	5	μs
Power dissipation	P _{tot}	T _C = 25°C	714	W
Maximum junction temperature	T _{J,max}		175	°C
Operating and storage temperature	TJ,TSTG		-55 to 175	°C
Max. lead temperature for soldering,	т		050	°C
1/8" from case for 5 seconds			250	C

1. +30V AC rating applies for turn-on pulses <200ns applied with external R_G > 1 Ω .

2. Limited by bondwires

3. Pulse width t_{p} limited by $T_{\text{J},\text{max}}$

Thermal Characteristics

Parameter	Symbol	Test Conditions	Value			Linita
			Min	Тур	Max	Units
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.16	0.21	°C/W

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Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Demonster	Symbol	Test Conditions	Value			L Instein
Parameter			Min	Тур	Max	- Units
Drain-source breakdown voltage	BV _{DS}	V _{GS} =-20V, I _D =2mA	750			V
	I _{DSS}	V _{DS} =750V,		4.0	100	— μΑ
Total drain loakago gurront		V _{GS} =-20V, T _J =25°C		15	120	
Total drain leakage current		V _{DS} =750V,		15		
		V _{GS} =-20V, T _J =175°C		05		
Total gate leakage current	I _{GSS}	V _{GS} =-20V, T _J =25°C		0.1	100	μA
		V _{GS} =-20V, T _J =175°C		0.3		μA
	R _{DS(on)}	V _{GS} =2V, I _D =80A,		4.8		mΩ
		TJ=25°C				
Drain-source on-resistance		V _{GS} =0V, I _D =80A,		5.4	6.6	
		TJ=25°C				
		V_{GS} =2V, I_{D} =80A,		10.4		
		т _ј =175°С				
		V_{GS} =0V, I_{D} =80A,		11.0		
		T_=175°C	11.7	11.7		
Gate threshold voltage	V _{G(th)}	V_{DS} =5V, I_{D} =180mA	-8.3	-6.0	-3.7	V
Gate resistance	R _G	f=1MHz, open drain		0.8		Ω

Typical Performance - Dynamic

Parameter	Symbol	Test Conditions	Value			Lipite
			Min	Тур	Max	Units
Input capacitance	C _{iss}	V===400V_V====20V		3028		
Output capacitance	C _{oss}	f=100kHz		364		pF
Reverse transfer capacitance	C _{rss}			360		
Effective output capacitance, energy	C _{oss(er)}	V _{DS} =0V to 400V,		440		
related		V _{GS} =-20V	440		рн	
C _{OSS} stored energy	E _{oss}	V _{DS} =400V, V _{GS} =-20V		36		μJ
Total gate charge	Q _G	V==400VL==80A		400		
Gate-drain charge	Q _{GD}	$v_{DS} = 400 v, v_{D} = 000 A,$		270		nC
Gate-source charge	Q _{GS}	$V_{GS} = -18V 100V$		60		

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Typical Performance Diagrams



Figure 1. Typical output characteristics at $T_J = -55$ °C, tp < 250 μ s



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Figure 2. Typical output characteristics at $T_J = 25^{\circ}C$, tp < 250μ s



Figure 3. Typical output characteristics at T_J = 175°C, tp < 250 μ s



Figure 4. Typical transfer characteristics at V_{DS} = 5V





Figure 5. Normalized on-resistance vs. temperature at V_{GS} = 0V and I_{D} = 80A



Figure 6. Typical drain-source on-resistances at $V_{GS} = OV$



Figure 7. Threshold voltage vs. junction temperature at V_{DS} = 5V and I_D = 180mA



Figure 8. Typical gate forward current at V_{DS} = 0V





Figure 9. Typical capacitances at f = 100kHz and V_{GS} = -20V



Figure 10. Typical stored energy in C_{OSS} at V_{GS} = -20V



Figure 11. Total power Dissipation

Figure 12. DC drain current derating

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Figure 13. Safe operation area at $T_C = 25^{\circ}C$, Parameter t_p

Figure 14. Maximum transient thermal impedance



Figure 15. Typical gate charge at V_{DS} = 400V and I_{D} = 80A





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TO-247-4L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE



DIM	INCHES		MILLIMETERS		
	MIN	MAX	MIN	MAX	
A	0.185	0.209	4.7	5.31	
A1	0.087	0.102	2.21	2.59	
A2	0.059	0.098	1.5	2.49	
b	0.039	0.055	0.99	1.4	
b2	0.065	0.094	1.65	2.39	
С	0.015	0.035	0.38	0.89	
D	0.819	0.845	20.8	21.46	
D1	0.515	-	13.08	-	
D2	0.02	0.053	0.51	1.35	
E	0.61	0.64	15.49	16.26	
е	0.100 BSC		2.54 BSC		
e1	0.19	0.21	4.83	5.33	
E1	0.53	-	13.46	-	
E2	0.14	0.16	3.56	4.06	
L	0.78	0.8	19.81	20.32	
L1	-	0.177	-	4.5	
ФР	0.14	0.144	3.56	3.66	
ΦΡ1	0.278	0.291	7.06	7.39	
Q	0.212	0.244	5.38	6.2	
S	0.243 BSC		6.17 BSC		



TO-247-4L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PART NUMBER DS_PN DE X = ASSI YY = YEA WW = WO

PART NUMBER = REFER TO DS_PN DECODER FOR DETAILS

X = ASSEMBLY SITE YY = YEAR WW = WORK WEEK LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY /TUBE : 30 UNITS

XYYWW

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